

SERIAL ATA PLUG FOR 1.8" HDD PLUG

1.0 SCOPE

This Product Specification covers the performance requirements of the Serial ATA / High Speed Serialized device plug connector.

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND SERIES NUMBER(S)

Product Name

Part Number

SERIAL ATA PLUG, RIGHT ANGLE SURFACE MOUNT, 1.8" HDD

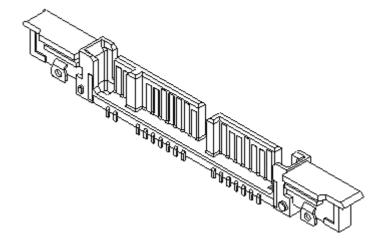
78103-0001

2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See Sales Drawing SD-78103-101 for information on dimensions, materials, platings and markings.

2.3 SAFETY AGENCY APPROVALS

| UL FILE | : | TBD |
|---------|---|-----|
| CSA | : | TBD |



TENTATIVE RELEASE :

THIS SPECIFICATION IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. PRELIMINARY TEST DATA MAY EXIST, BUT THIS SPECIFICATION IS SUBJECTED TO CHANGE BASED ON THE RESULTS OF ADDITIONAL TESTING AND EVALUATION.

| | REVISION: | ECR/ECN INFORMATION: | TITLE: SEF | RIAL ATA PLUG | | SHEET No. |
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| | 2 | EC No: S2008-0484 | RIGHT ANO | RIGHT ANGLE, SURFACE MOUNT 1.8" HDD | | |
| | | <u>DATE:</u> 2007/11/29 | | | | |
| | DOCUMENT NUMBER: | | CREATED / REVISED BY: | CHECKED BY: | APPRO | <u>OVED BY:</u> |
| | | YKOH 2007/12/12 | KCLING | 2007/12/12 | | |
| | | | | TEMPLATE FILENAM | E: PRODUCT_SPE | C[SIZE_A4](V.1).DOC |



3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

The following documents form a part of this specification to the extend specified herewith. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In addition, in event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

Serial ATA Workgroup Specification

4.0 RATINGS

4.1 VOLTAGE 30 Volts Max.

4.2 CURRENT 1.5 Amps DC or AC (RMS). Max. @ 60 Hz

4.3 TEMPERATURE Operating : - 40°C to + 105°C Non-Operating : - 40°C to + 105°C

4.4 HUMIDITY 20% - 80%

20% - 00%

4.5 PRESSURE

650 mm – 800 mm Hg

| REVISION: | ECR/ECN INFORMATION: | TITLE: SEF | RIAL ATA PLUG | | SHEET No. |
|-----------|--------------------------|-----------------------|------------------|----------------|-----------------------|
| 2 | EC No: S2008-0484 | | BLE, SURFACE M | OUNT | 2 of 10 |
| - | DATE: 2007/11/29 | | 1.8" HDD | | |
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5.0 PERFORMANCE

5.1 ELECTRICAL REQUIREMENTS

| ITEM | DESCRIPTION | TEST CONDITION | REQUIREMENT | |
|------|---|--|--|--|
| 1 | Low Level Contact Resistance (LLCR) | Subject mated contacts assembled in housing to 20 mV maximum open circuit at 100 mA maximum. (EIA 364-23) | 30 mΩ MAXIMUM [initial] Resistance increase 15 mΩ MAXIMUM [after stress] | |
| 2 | Insulation Resistance | After 500 VDC for 1 minute, measure the insulation resistance between adjacent terminals of the mated and unmated connector assemblies. (EIA 364-21) | 1000 Megohms MINIMUM | |
| 3 | Dielectric Withstanding Voltage | Subject a voltage of 500 VAC for 1 minute between adjacent terminals of mated and unmated connector at sea level. (EIA 364-20 Method B) | No breakdown | |

| REVISION: | ECR/ECN INFORMATION: | TITLE: SEF | RIAL ATA PLUG | | SHEET No. |
|-----------|---------------------------------|----------------------------|------------------|-----------------------|---------------------|
| 2 | <u>EC No:</u> S2008-0484 | RIGHT ANGLE, SURFACE MOUNT | | 3 of 10 | |
| L | <u>DATE:</u> 2007/11/29 | | 1.8" HDD | | |
| DOCUMEN | T NUMBER: | CREATED / REVISED BY: | CHECKED BY: | APPRO | <u>OVED BY:</u> |
| PS | S-78103-002 | GMENARLY 2007/11/29 | YKOH 2007/12/12 | KCLING | 2007/12/12 |
| | | | TEMPLATE FILENAM | E: PRODUCT_SPE | C[SIZE_A4](V.1).DOC |



| | 4 | Connector Insertion and Removal Forces (SATA Backplane and Cables) | Mate and Unmate connector assemblies at a rate of 12.5 mm per minute. (EIA 364-13) | (1) Backp (2)Cable (Power (1) Backp (af (2)Cable (1) (a (1) th (3)Cable (1) | UM insertio plane Recep 20N Receptacle: r or Signal) 45N And UM remova plane Recep 2.5N ter 500 cycle 10N fter 50 cycle 10N mough 5 cycle Signal Rece Non-Latching 10N fter 50 cycle | tacle: I force tacle: es) eptacle: g) eptacle: g) |
|---------|------------|--|--|---|--|--|
| | 5 | Durability | 50 cycles for internal cabled application, 500 cycles for backplane/blindmate application. All at a maximum rate of 200 cycles per hour. (EIA 364-09) | Meet additiona the t | Physical dam t requiremen l tests as sp test sequence Section 7.0 | nts of ecified in ce in |
| | 6 | Resistance to Soldering Heat | Refer to Section 10.0 for soldering profile. | No dama | age in appea connector | arance of |
| | 7 | Terminal Retention Force | Apply axial pull out force on terminal in the housing at a rate of 25.4 mm per minute. | MINIM | 4.45 N UM retentio | n force |
| | | | | | | |
| REVISIO | <u>)N:</u> | ECR/ECN INFORMATION: | | | | SHEET No. |
| 2 | | EC No: S2008-0484 | RIGHT ANGLE, SURF | | OUNT | 4 of 10 |
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PS-78103-002

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| | 8 | Physical Shock | Subject mated connector to 30 g's half-sine shock pulses of 11 msec duration. Three shocks in each direction applied along three mutually perpendicular planes for a total of 18 shocks. (EIA 364-27 Condition H) | No Physical damage No discontinuities of 1 μs or longer duration Test Set-Up in Section 8.0 | |
|---|--------------------|----------------|--|---|--|
| - | 9 Random Vibration | | Subject mated connector to 5.35 g's RMS. 30 minutes in each of the three mutually perpendicular planes. (EIA 364-28 Condition V Test letter A) | No discontinuities of 1 μs or longer duration Test Set-Up in Section 8.0 | |
| - | 10 | Solderability | Solder Time: 3 ± 0.5 seconds Solder Temperature: 260 ± 5 °C (MIL-STD-202, Method 208) | Dipped portion should have 95 % continuous new solder coating coverage | |

5.3 ENVIRONMENTAL REQUIREMENTS

| ITEM | DESCRIPTION | TEST CONDITION | REQUIREMENT |
|------|------------------|--|---|
| 11 | Temperature Life | Subject mated connector to temperature life at + 85 °C for 500 hours. (EIA 364-17 Test Condition III Method A) | No Physical damage Meet requirements of additional tests as specified in the test sequence in Section 7.0 |
| 12 | Thermal Shock | Subject connector to 10 cycles between - 55 °C and + 85 °C. (EIA 364-32 Test Condition I) | No Physical damage Meet requirements of additional tests as specified in the test sequence in Section 7.0 |

| REVISION: 2 | ECR/ECN INFORMATION: EC No: \$2008-0484 DATE: 2007/11/29 | | RIAL ATA PLUG BLE, SURFACE M 1.8" HDD | OUNT | <u>SHEET No.</u> 5 of 10 |
|----------------|--|-----------------------|---|----------------|-----------------------------|
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| | | | TEMPLATE FILENAM | E: PRODUCT_SPE | C[SIZE_A4](V.1).DOC |



| 1 | 3 | Humidity | Subject the connector to temperature and humidity of 40 °C with 90 % to 95 % RH for 96 hours. (EIA 364-31 Method II Test Condition A) | |
|---|---|-------------------|---|----------------------|
| 1 | 4 | Mixed Flowing Gas | Half of the samples are exposed unmated for 7 days, then mated for the remaining 7 days. The other half of the samples mated for full 14 days test period. (EIA 364-65, Class 2A) | Meet requirements of |

6.0 PACKAGING

Refer to Sales Drawing SD-78103-101 for packaging details.

| REVISION: | ECR/ECN INFORMATION: | TITLE: SEF | RIAL ATA PLUG | | SHEET No. |
|-----------|---------------------------|-------------------------------|-----------------------|----------------|---------------------|
| 2 | EC No: \$2008-0484 | KIGHT ANGEL, SUKTACE MOUNT 60 | 6 of 10 | | |
| | <u>DATE:</u> 2007/11/29 | | 1.8" HDD | | |
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| | | | TEMPLATE FILENAM | E: PRODUCT_SPE | C[SIZE_A4](V.1).DOC |



7.0 TEST SEQUENCES

| Test Group ∨ | Α | В | С | D | Е | F | G | Н |
|--|------|------|---------|------|------|------|------|---|
| Test or Examination ⇐ | | | | | | | | |
| Examination of the connector(s) | 1, 5 | 1, 9 | 1, 8 | 1, 8 | 1, 7 | 1 | 1, 5 | |
| Low Level Contact Resistance (LLCR) | 2, 4 | 3, 7 | 2, 4, 6 | | 4, 6 | | | |
| Insulation Resistance | | | | 2, 6 | | | | |
| Dielectric Withstanding Voltage | | | | 3, 7 | | | | |
| Current Rating | | | 7 | | | | | |
| Insertion Force | | 2 | | | | | 2 | |
| Removal Force | | 8 | | | | | 4 | |
| Durability | 3 | 4(a) | | | 2(a) | | 3 | |
| Physical Shock | | 6 | | | | | | |
| Vibration | | 5 | | | | | | |
| Humidity | | | | 5 | | | | |
| Temperature Life | | | 3 | | | | | |
| Reseating (manually unplug/plug three times) | | | 5 | | 5 | | | |
| Thermal Shock | | | | 4 | | | | |
| Terminal Retention Force | | | | | | 2, 4 | | |
| Resistance to Soldering Heat | | | | | | 3 | | |
| Solderability | | | | | | | | 1 |
| Mixed Flowing Gas | | | | | 3 | | | |

Note:-

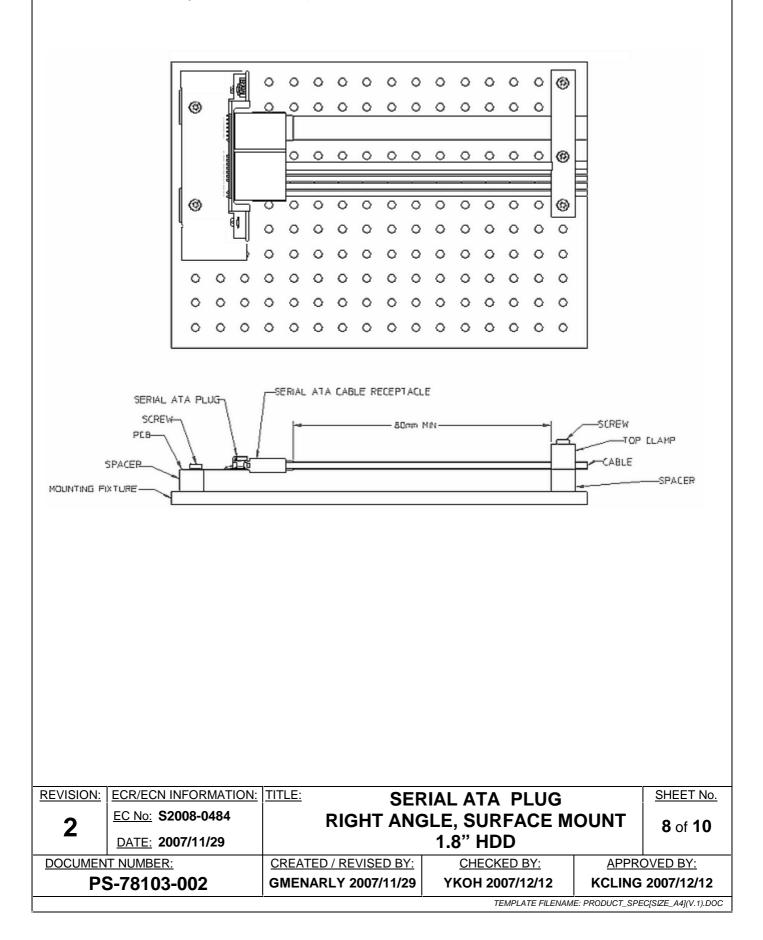
(a) Preconditioning, 20 cycles for the 50-durability cycle requirement, 50 cycles for the 500durability cycles requirement. The insertion and removal cycle is at the maximum rate of 200 cycles per hour.

| REVISION: | ECR/ECN INFORMATION: | TITLE: SERIAL ATA PLUG | | | SHEET No. | |
|---|-------------------------|------------------------|-----------------------------------|--------------|------------|--|
| 2 | EC No: S2008-0484 | RIGHT ANG | RIGHT ANGLE, SURFACE MOUNT | | | |
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| DOCUMENT NUMBER: | | CREATED / REVISED BY: | CHECKED BY: | APPROVED BY: | | |
| PS-78103-002 | | GMENARLY 2007/11/29 | YKOH 2007/12/12 | KCLING | 2007/12/12 | |
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8.0 VIBRATION/SHOCK TEST SET-UP (REFERENCE ONLY)

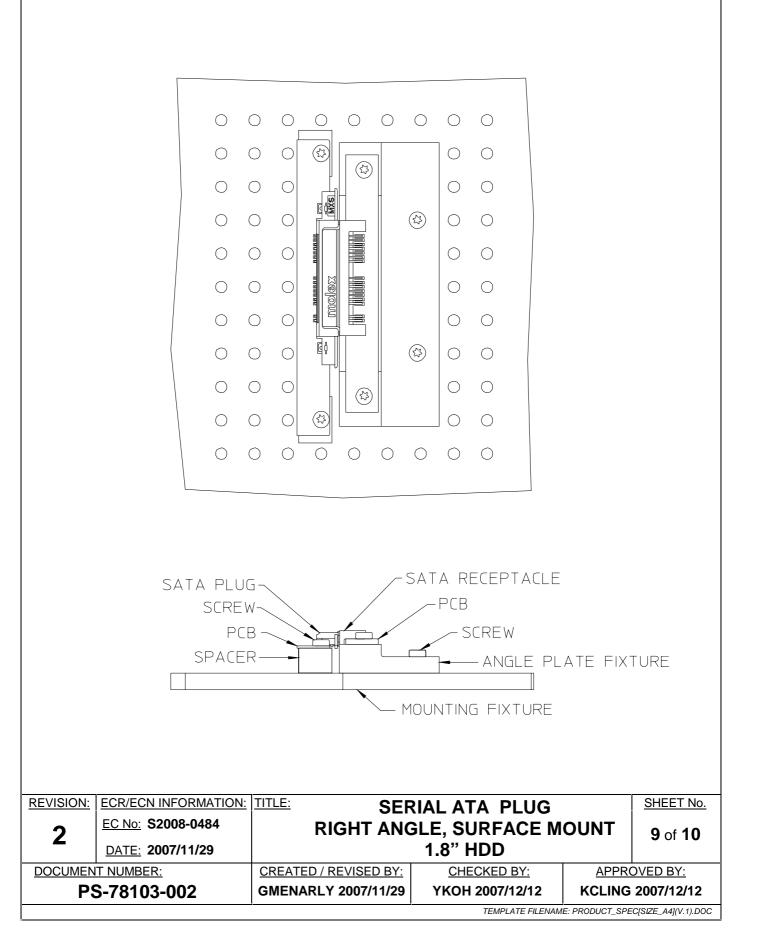
Serial ATA Plug with Cable Receptacle





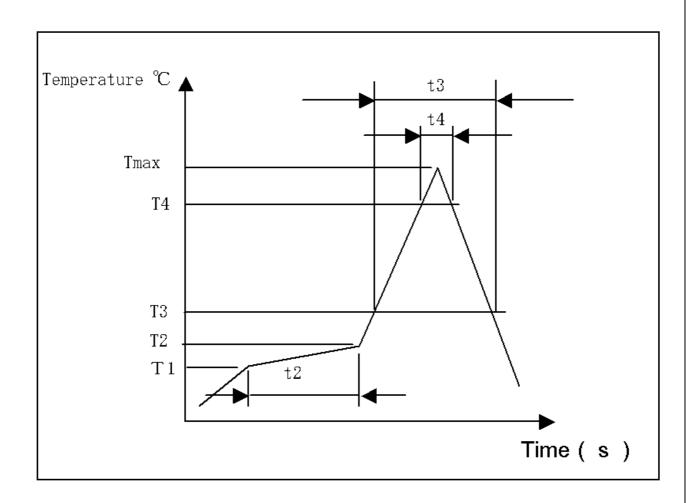
9.0 VIBRATION/SHOCK TEST SET-UP (REFERENCE ONLY)

Serial ATA Plug with Blind-mate Receptacle





10.0 SOLDERING PROFILE



| Description | Requirement |
|-------------------------|---|
| Tmax | 260°C |
| T4, t4 | 255°C, 10 second max. |
| T3, t3 | 220°C, 80 second max. |
| T1 & T2, t2 | $170 \pm 10^{\circ}$ C, 160 second max. |
| Number of reflow passes | 2 |

| REVISION: | ECR/ECN INFORMATION: | TITLE: SEF | RIAL ATA PLUG | | SHEET No. | |
|--|---------------------------|-----------------------------------|-----------------|-------------------|------------------------|--|
| 2 | EC No: \$2008-0484 | RIGHT ANGLE, SURFACE MOUNT | | | 10 of 10 | |
| L | <u>DATE:</u> 2007/11/29 | 1.8" HDD | | | | |
| DOCUMENT NUMBER: | | CREATED / REVISED BY: | CHECKED BY: | APPROVED BY: | | |
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